

INTERSIL P/N:	BMS-PS-CELL16Z
RoHS Compliant Required?	YES
REV #	A
SOLDER SAMPLE:	0
NUMBER OF LAYERS:	2
BOARD DIMENSIONS:	X 3.45
	Y 2.9
THICKNESS:	.062
COPPER WEIGHT:	1 OZ
MATERIAL:	FR4(ROHS)
TOTAL HOLE QTY:	128
	LARGEST: 41 mil
	SMALLEST: 20 mil
THRU HOLE:	
SMD:	
TOTAL NUMBER OF SMD PADS:	132
	# TOP: 132
	# BOTTOM: 0
TRACES & SPACES?	
PLATING REQ'D ?	
	SMOBC? NO
	IMMERSION GOLD? YES (ROHS)
	HARD GOLD? NO
	OTHER? N/A
ARRAY FORMAT REQUIRED?	NO
TEST REQUIRED	100% TEST W/NETLIST PROVIDED (IPC 356)
CONTROLLED IMPEDANCE?	NO
	VALUE?
	+/- PERCENT?
	LINE WIDTH?
	BETWEEN LAYERS?
	TDR COUPON REQ'D?
	TDR COUPON DATA REQUESTED?
BLIND/BURIED VIAS? (If yes, what layers?)	NO
SILKSCREEN: (1 SIDED OR 2 SIDED)	1 side
SOLDERMASK:	RED
COMMENTS:	